

# W-LAN + Bluetooth Combo Module Data Sheet

802.11b/g/n and Bluetooth v4.0 module

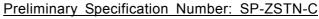
**Product Part Number: LBEE5ZSTNC-523** 





# **Revision History**

Revision Code	Date	Description	Comments
С		Updated: Module Features for U.FL connector. Add: Indication for U.FL connector. Updated: Pin description	
В	Oct.21Aug.1 8.2011	Add: Module Features Update: Notice for Murata Wireless Modules Update: Taping and Reel information	
А	Jul.15.2011	Update: Component Height Update: Current Consumption	
-	Apr.28.2011	First Issue	





Notice for Murata Wireless Modules.

Please read the specification including the NOTICE (Page29) and the Disclaimer (Page33) in this datasheet before using the Murata Wireless Modules.



#### Module Features

- Murata LBEE5ZSTNC module integrates WLAN and Bluetooth functions.
- WLAN: IEEE 802.11 b, g, n compliant.
- Bluetooth: Bluetooth version 4.0 with Bluetooth Low Energy (BLE). Power Class 1.5.
- Typical WLAN Transmit Power (typical):
  - +20.0dBm at 11Mbps, CCK (11b)
  - +15.0dBm at 54Mbps, OFDM (11g)
  - +14.5dBm at 65Mbps, OFDM (11n)
- Typical Bluetooth Transmit Power (typical):
  - +8.0dBm BDR
- Typical WLAN Sensitivity (typical):
  - -88.0dBm at 8% PER, 11Mbps
  - -73.0dBm at 10% PER, 54Mbps
  - -70.0dBm at 10% PER, 65Mbps
- Typical Bluetooth Sensitivity (typical):
  - -92.0dBm DH5
  - -85.0dBm EDR
- Module size: 17.0x10.0mm typical.
- Module height: 2.2mm max.
- FCC (USA) and IC (Canada) Certification with mono-pole type antenna.
  - FCC ID: VPYLBTN, IC ID: 772C-LBTN
- U.FL connector for external antenna connection is selectable but additional certification tests are required.
- Integrated Band Pass Filter
- Seamless integration with several Texas Instruments OMAP<sup>TM</sup>, SITARA<sup>TM</sup>, DaVinci<sup>TM</sup> and Integra<sup>TM</sup> processors
- SDIO host interface for WLAN
- UART host interface for Bluetooth, PCM interface for Audio.
- RoHS Compliance





#### 1. Scope

This specification is applied to the IEEE802.11 b/g + Bluetooth ver. 4.0 module.

Host Interface

- W-LAN : SDIO, - Bluetooth : UART, PCM

IC/ Firmware version.

- W-LAN/BT BB/MAC : Texas Instruments WL1271L (PG3.32)

- FEM for WL1271 : TriQuint TQM679002A (ES2.6)

Reference Clock : 38.4MHz Reference Clock is integrated. Sleep Clock : External 32.768 kHz oscillator is required.

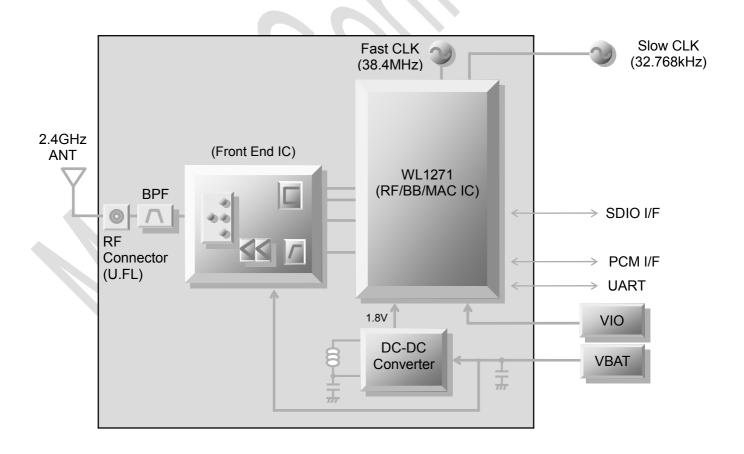
Weight : T.B.D (mg)
MSL : Level 3

**RoHS Compliance** 

#### 2. Part Number

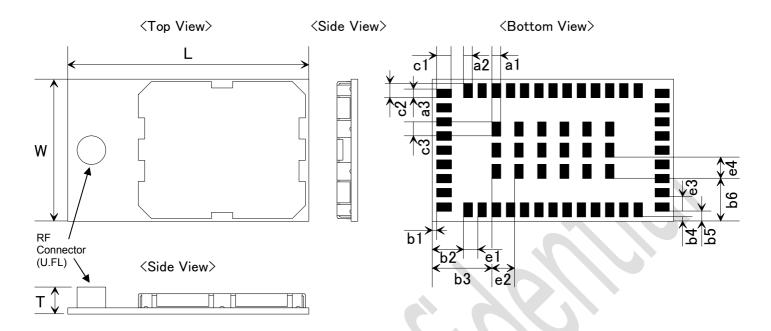
Part Number	LBEE5ZSTNC-523

#### 3. Block Diagram





# 4. Dimensions and Terminal Configurations



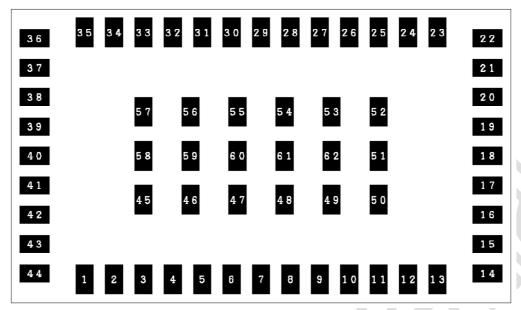
### Dimensions

(unit: mm)

Mark	Dimensions	Mark	Dimensions	Mark	Dimensions
L	17.0 +/- 0.2	W	10.0 +/- 0.2	Т	2.2 max.
a1	0.6 +/- 0.1	a2	0.6 +/- 0.1	a3	0.6 +/- 0.1
b1	0.3 +/- 0.2	b2	2.2 +/- 0.2	b3	4.2 +/- 0.2
b4	0.3 +/- 0.2	b5	0.7 +/- 0.2	b6	3.0 +/- 0.2
c1	1.0 +/- 0.1	c2	1.0 +/- 0.1	c3	1.0 +/- 0.1
e1	1.0 +/- 0.1	e2	1.6 +/- 0.1	e3	1.0 +/- 0.1
e4	1.5 +/- 0.1	-	-	-	-



#### Terminal configuration



<Top View>

						0 " '	
No.	Terminal Name	Type	Power	System		Connection to IC Terminal	Description
1	GND	-	-	-	-		Ground
2,3	VBAT	Р			1271/	PMS VBAT,	Power supply input
2,3		٢	-	-	LDO	DCDC Converter	
4	GND	-			-	-	Ground
5	UART_DBG	I/O	-	WLAN	1271	WL_UART_DBG	WL_UART_DBG Should be connected to TP on board for software debug.
6	WLAN_EN		-	WLAN	1271	WL_EN	WL_RST
7	RS232_RX	I/O	-	WLAN	1271	WL_RS232_Rx	RS232_Rx or I2C_M_SCL
8	RS232_TX	I/O	-	WLAN	1271	WL_RS232_Tx	RS232_Tx or I2C_M_SDA
9	WLAN_IRQ	0	-	WLAN	1271	WLAN_IRQ	WLAN interrupt request
10	BT_EN		-	BT	1271	BT_EN	BT_RST
11	NC	10	-	BT	1271	BT_FUNC1	NC
12	VIO	Р		<u>-</u>	1271	VDDS1 VDDS2 VDDS3 VDDS4	Power supply input
13	GND	)	-	-	-	-	Ground
14	SDIO_D2	1/0	-	WLAN	1271	SDIO_D2	SDIO mode: DATA 2
15	SDIO_CMD	I/O	-	WLAN	1271	SPI_DIN	SDIO mode: CMD
16	SDIO_CLK	I	-	WLAN	1271	SPI_CLK	SDIO mode: CLK
17	SDIO_D0	I/O	-	WLAN	1271	SPI_DOUT	SDIO mode: DATA 0
18	SDIO_D1	I/O	-	WLAN	1271	SDIO_D1	SDIO mode: DATA 1
19	SDIO_D3	I/O	-	WLAN	1271	SPI_CSX	SDIO mode :DATA 3
20	GND	-	-	-	-	-	Ground
21	SLEEP_CLK		-	-	1271	SLOWCLK	SLEEP_CLK input
22	GND	1	-	-	-	-	Ground
23	AUD_IN	ı		BT	1271	AUD_IN	PCM I/F
24	AUD_OUT	0		ВТ	1271	AUD_OUT	PCM I/F
25	AUD_FSYNC	I/O	-	BT	1271	AUD_FSYNC	PCM I/F
26	AUD_CLK	I/O	-	BT	1271	AUD_CLK	PCM I/F



# Preliminary Specification Number: SP-ZSTN-C P. 8/34

27								P. 8/34
29	27	UART_RTS	I/O	-	BT	1271		BT UART I/F
30	28	UART_CTS	I/O	-	BT	1271	HCI_CTS	BT UART I/F
31				-	BT		HCI_TX	BT UART I/F
STANDES	30	UART_RX	I/O	-	BT	1271	HCI_RX	BT UART I/F
32   BT_TX_DBG	31	GND	-	-	-	-	-	Ground
Software debug.   Software debug.   Software debug.								
33	32	BT_TX_DBG	I/O	-	BT	1271	BT_FUNC4	Should be connected to TP for
34								
35		NC		-			BT_FUNC6	
36	_		I/O	-	BT	1271	BT_FUNC5	
37			-	-	-	-	-	
38			-	-	-	-	-	
39			-	-	-	-	-	
40   2.4G_ANT			-	-	-	-	-	
40	39	GND	-	-	-	-	-	
AN	40	24G ANT	1/0	_		_	_	
42         GND         -         -         -         -         Ground           43         GND         -         -         -         -         Ground           44         GND         -         -         -         Ground           45         GND         -         -         -         Ground           46         GND         -         -         -         Ground           47         GND         -         -         -         Ground           48         GND         -         -         -         Ground           49         GND         -         -         -         Ground           50         GND         -         -         -         Ground           51         GND         -         -         -         -         Ground           51         GND         -         -         -         -         -         Ground           52         GND         -         -         -         -         -         Ground           53         GND         -         -         -         -         -         Ground           54 <td< td=""><td></td><td>_</td><td>1/0</td><td></td><td>AN</td><td></td><td><u>-</u></td><td></td></td<>		_	1/0		AN		<u>-</u>	
43         GND         -         -         -         -         Ground           44         GND         -         -         -         -         Ground           45         GND         -         -         -         -         Ground           46         GND         -         -         -         -         Ground           47         GND         -         -         -         -         Ground           48         GND         -         -         -         -         Ground           49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           51         GND         -         -         -         -         -         Ground           52         GND         -         -         -         -         -         Ground           53         GND         -         -         -         -         -         -         -         Ground           55			-	-	-	-	-	
44         GND         -         -         -         -         Ground           45         GND         -         -         -         -         Ground           46         GND         -         -         -         -         Ground           47         GND         -         -         -         -         Ground           48         GND         -         -         -         -         Ground           49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         -         Ground           53         GND         -         -         -         -         -         Ground           54         GND         -         -         -         -         -         Ground           55         GND         - <td></td> <td></td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td></td>			-	-	-	-	-	
45         GND         -         -         -         -         Ground           46         GND         -         -         -         -         Ground           47         GND         -         -         -         -         Ground           48         GND         -         -         -         -         Ground           49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         -         Ground           54         GND         -         -         -         -         -         Ground           55         GND         -         -         -         -         -         Ground           56         GND         - <td></td> <td></td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td></td>			-	-	-	-	-	
46         GND         -         -         -         Ground           47         GND         -         -         -         Ground           48         GND         -         -         -         Ground           49         GND         -         -         -         Ground           50         GND         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         -         Ground           53         GND         -         -         -         -         -         Ground           54         GND         -         -         -         -         -         Ground           55         GND         -         -         -         -         -         Ground           56         GND         -         -         -         -         -         -         Ground           58         GND         -         -         -         -         -         -         -         -         Ground           60			-	-	-	-	-	
47         GND         -         -         -         -         Ground           48         GND         -         -         -         -         Ground           49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         -         Ground           57         GND         -<			-	-	-	-	-	
48         GND         -         -         -         -         Ground           49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         -         Ground           58         GND         -         -         -         -         -         Ground           59         GND         -         -         -         -         -         -         Ground           60         GND <td></td> <td></td> <td>-</td> <td>-</td> <td>-</td> <td></td> <td></td> <td></td>			-	-	-			
49         GND         -         -         -         -         Ground           50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         -         Ground           60         GND         -         -         -         -         -         Ground           61         GND         -         - <td></td> <td></td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td>-</td> <td></td>			-	-	-	-	-	
50         GND         -         -         -         -         Ground           51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         -         Ground           60         GND         -         -         -         -         -         Ground           61         GND         -         -         -         -         -         -         -         -         -         -			-	-	-	-	-	
51         GND         -         -         -         -         Ground           52         GND         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         -         Ground           60         GND         -         -         -         -         -         Ground           61         GND         -         -         -         -         -         -         -         -         -         -         -         -         -         -         -         -         -         -         -<			-	-	-	-		
52         GND         -         -         -         -         -         Ground           53         GND         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         -         Ground			-	-	-		-	
53         GND         -         -         -         -         -         Ground           54         GND         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	-	-	_	-	
54         GND         -         -         -         -         -         Ground           55         GND         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	_	-	-	-	
55         GND         -         -         -         -         -         Ground           56         GND         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground	53		-	-	-	1	-	
56         GND         -         -         -         -         -         Ground           57         GND         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	-	-	-	-	
57         GND         -         -         -         -         -         Ground           58         GND         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	-	-	1	-	Ground
58         GND         -         -         -         -         -         Ground           59         GND         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	-	-	-	-	Ground
59         GND         -         -         -         -         -         Ground           60         GND         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			_	-	-	<b>1</b> -	-	Ground
60         GND         -         -         -         -         -         Ground           61         GND         -         -         -         -         Ground			-	-	-	7 -	-	Ground
61 GND Ground	59	GND	_ \	<b>—</b>	-	-	-	Ground
	60	GND	-		-	-	-	Ground
62 GND Ground			-	-	-	_	-	Ground
	62	GND	-		-	_	-	Ground



# 5. Absolute Maximum Rating

Parame	min.	max	unit	
Storage Tem	-40	85	deg.C	
Supply Voltage	VBAT	-0.5	4.8	V
	VIO	-0.5	2.1	V

# 6. Operating Condition

Parame	min.	typ.	max	unit	
Operating Ter	-30	25	70	deg.C	
Cupply Voltage	VBAT	2.7	3.6	4.8	V
Supply Voltage	VIO	1.65	1.8	1.92	V

# 7. Input/Output Terminal Characteristic

	Condition	min.	max	unit
VIH: High-level input voltage(VDD_IO = IO supply for ring)	Default	0.7 x VIO	VIO	V
Vı∟:Low-level input voltage	Default	0	0.35 x VIO	V
	4mA	VIO - 0.45	VIO	V
Voн:High-level output voltage	1mA	VIO - 0.112	VIO	V
	0.3mA	VIO-0.033	VIO	V
	4mA	0	0.45	V
Vol:Low-level output voltage	1mA	0	0.112	V
	0.09mA	0	0.01	V





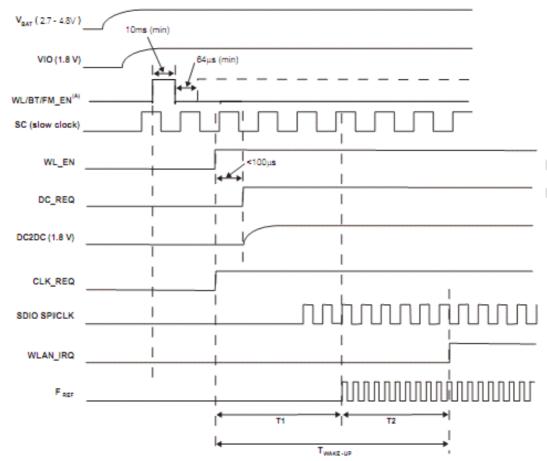
# 8. External Slow Clock specification

Characteristics(*)	Condition	min.	Тур.	max	unit
Input slow clock frequency			32.768		kHz
Input slow clock accuracy	WLAN, BT,			±150	ppm
Input transition time Tr/Tf -10% to 90%	Tr/Tf			100	ns
Frequency input duty cycle		30	50	70	%
Input voltage limits	Square wave,	0.65×VIO		VIO	V
Imput voitage iimits	DC-coupled	0		0.35×VIO	V
Input impedance		1			ΜΩ
Input capacitance				5	pF
Rise and fall time				100	ns
Phase noise				-125	dBc/Hz



#### 9. WLAN Power Up/Down Sequence

#### 9.1 Power Up Sequence



A. After this sequence is completed, the device is in the low VIO-leakage state while in shutdown.

The following sequence describes device power up from shutdown. Only the WLAN Core is enabled; the BT and FM cores are disabled.

- 1. No signals are allowed on the IO pins if no IO power supplied, because the IOs are not 'fail safe'. Exceptions are SLEEP\_CLK and AUD\_xxx, which are failsafe and can tolerate external voltages with no VIO and DC2DC.
- 2. VBAT, VIO and SLEEP\_CLK must be available before WLAN\_EN.
- 3. Twakeup = T1 + T2

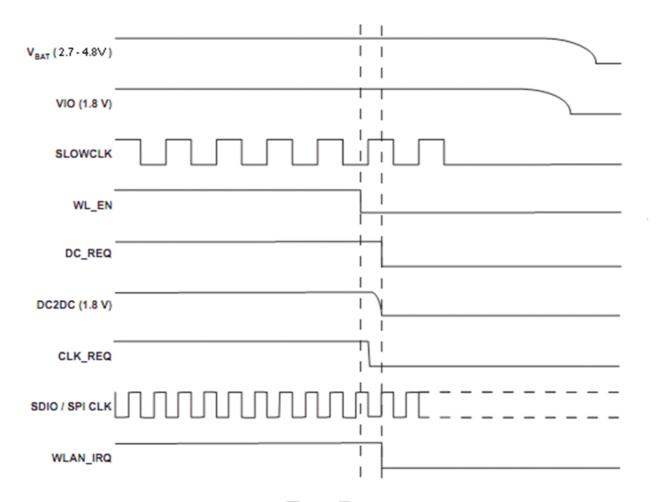
The duration of T1 is defined as the time from WLAN\_EN=high until Fref is valid for the WL1271 SoC T1 ~55ms

The duration of T2 depends on:

- Operating system
- Host enumeration for the SDIO
- PLL configuration
- Firmware download
- Releasing the core from reset
- Firmware initialization



#### 9.2 Power Down Sequence



- 1. DC\_REQ of WL1271 will go low only if WLAN is the only core working. otherwise if another core is working (e.g BT) it will stay high.
- 2. If WLAN is the only core that is operating, WLAN\_EN must remain de-asserted for at least 64msec before it is re-asserted.



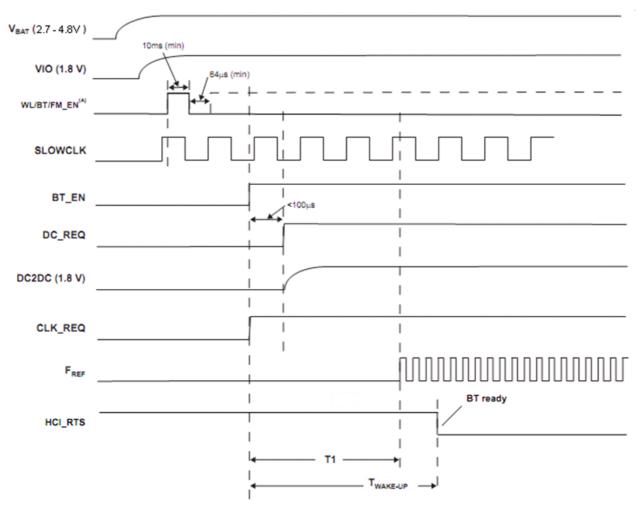
#### 10. BT Power Up/Down Sequence

#### 10.1 Power Up Sequence

The following sequence describes device powerup from shutdown. Only the BT core is enabled; the WLAN and FM cores are disabled.

#### Power up requirements:

- 1. No signals are allowed on the IO pins if no IO power supplied, because the IOs are not 'failsafe'. Exceptions are SLEEP\_CLK and AUD\_xxx, which are failsafe and can tolerate external voltages with no VIO and DC2DC.
- 2. VIO and SLEEP\_CLK must be stable before releasing BT\_EN.
- 3. Fast clock must be stable maximum 55ms after BT\_EN goes HIGH.

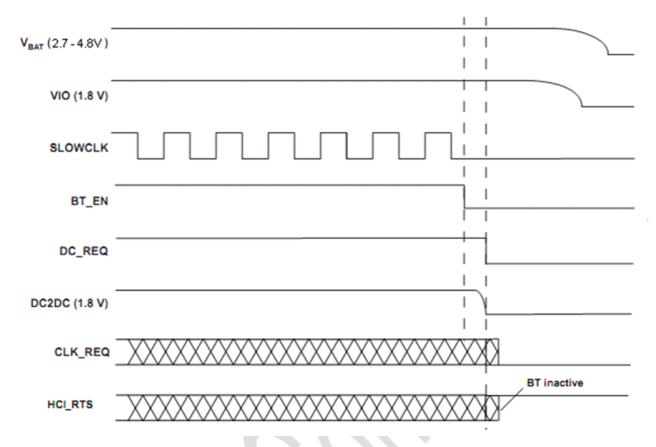


A. After this sequence is completed, the device is in the low VIO-leakage state while in shutdown.

- 1. The duration of T1 is defined as the time from BT EN=high until Fref is valid for the WL1271.
- 2. T1≒55ms
- 3. The duration of  $T_{WAKE-UP}$  is defined as the time from BT\_EN rising edge to HCI\_RTS falling edge, <70ms.



### 10.2 Power Down Sequence



The WL1271 indicates completion of BT power up sequence by asserting RTS low. This occurs up to 100ms after BT\_EN goes high.



#### 11. HOST Interface

#### 11.1 Host interface Combination

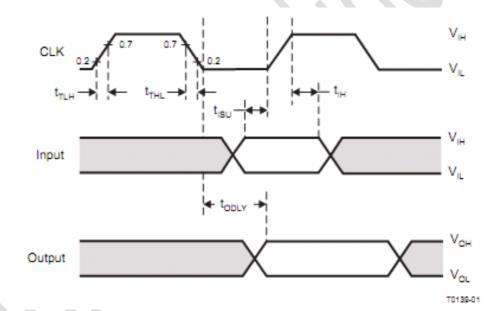
WLAN	BT	Remarks
SDIO	UART	

#### 11.2 SDIO Interface

### 11.2.1 SDIO Clock Switching Characteristics

Note: all timing parameter are indicated for the maximum Host interface clock frequency.

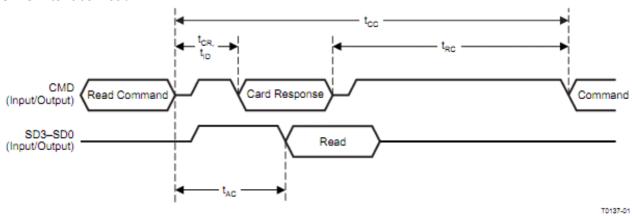
	PARAMETER		MIN	MAX	UNIT
Fclock	Clock frequency,CLK	CL ≦30pF	0	25	MHz
DC	Low/High duty cycle	CL ≦30pF	40	60	%
tTLH	Rise time, CLK	CL ≦30pF		4.3	ns
tTHL	Fall time, CLK	CL ≦30pF		3.5	ns
tISU	Setup time, input calid before CLK↑	CL ≦30pF	4		ns
tIH	Hold time, input valid after CLK↑	CL ≦30pF	5		ns
tODLY	Delay time, CLK↓ to output valid	CL ≦30pF	2	12	ns





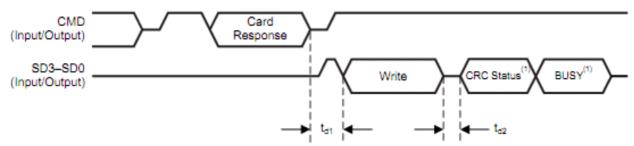
### 11.2.2 SDIO Data Switching Characteristics

#### SDIO Interface Read



MIN MAX Unit Parameter Delay time, assign relative address or data transfer Read-command CMD invalid to card-response Clock tCR 2 64 CMD valid Cycle Clock 58 tCC Delay time, CMD command invalid to CMD command valid Cycle Clock 8 tRC Delay time, CMD response invalid to CMD command valid Cycle Clock 2 tAC Access time, CMD command invalid to SD3-SD0 read data valid Cycle

#### SDIO Interface Write



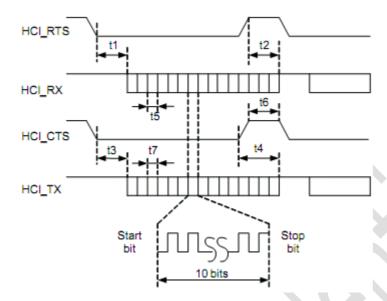
T0138-01

NOTE: CRC status and busy waveforms are only for data line 0. Data lines 1–3 are N/A. The busy waveform is optional, and may not be present.

	Parameter	MIN	MAX	Unit
T <sub>d1</sub>	Delay time,CMD card response invalid to SD3-SD0 write data valid	2		Clock Cycle
T <sub>d2</sub>	Delay time,SD3-SD0 wirte data invalid end to CRC status valid	2	2	Clock Cycle



# 11.3 UART Interface timing



Symbol	Characteristics	Condition	MIN	Тур	MAX	Unit
	Baud rate	Most rates	37.5		4000	kbps
t5,t7	Baud rate accuract	Receive/Transmit	-2.5		1.5	%
t3	CTS low to TX_DATA		0	2		us
t4	CTS high to TX_DATA	Hardware flow control			1	byte
t6	CTS-high pulse width		1			bit
t1	RTS low to RX_DATA on		0	2		us
t2	RTS high to RX_DATA off	Interrupt set to 1/4 FIFO			16	byte





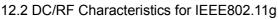
#### 12. Electrical Characteristics

#### 12.1 DC/RF Characteristics for IEEE802.11b

11Mbps mode unless otherwise specified. 25deg.C, VBAT=3.6V, VDDIO=1.8V

Items	Contents				
Specification	IEEE802.11b				
Mode	DSSS / CCK				
Frequency	2400 – 2483.5MHz				
Data rate	1, 2, 5.5, 11Mbps				
- DC Characteristics -	min.	typ.	max.	unit	
1. DC current					
1) Tx mode at VBAT	-	250		mA	
2) Rx mode at VBAT	-	90		mA	
3) Sleep mode at VBAT	-	90		uA	
- Tx Characteristics -	min.	typ.	max.	unit	
2. Power Levels		19.5		dBm	
3. Spectrum Mask					
1) 1st side lobes	_	-	-30	dBr	
2) 2nd side lobes	-	-	-50	dBr	
4. Power-on and Power-down ramp	-	-	2	µsec	
5. RF Carrier Suppression	15	-	-	dB	
Modulation Accuracy (EVM)	-	-	35	%	
- Rx Characteristics -	min.	typ.	max.	unit	
8. Minimum Input Level Sensitivity					
1) 11Mbps (FER ≤ 8%)	-	-	-76	dBm	



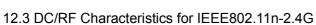


muRata

12.2 DC/RF Characteristics for IEEE802.11g 54Mbps mode unless otherwise specified. 25deg.C, VBAT=3.6V, VDDIO=1.8V

Items	Contents				
Specification	IEEE802.11g				
Mode	OFDM				
Frequency	2400 - 2483.5MHz				
Data rate	6, 9, 12, 18, 24, 36, 48, 54Mbps				
- DC Characteristics -	min.	typ.	max.	unit	
1. DC current					
1) Tx mode at VBAT	-	175	-	mA	
2) Rx mode at VBAT	-	90	-	mA	
3) Sleep mode at VBAT	-	90	-	uA	
- Tx Characteristics -	min.	typ.	max.	unit	
2. Power Levels		14.0		dBm	
3. Spectrum Mask			25 / /		
1) at fc +/- 11MHz	-		-20	dBr	
1) at fc +/- 20MHz	-		-28	dBr	
1) at fc +/- 30MHz	-		-40	dBr	
4. Spurious Emissions					
- Rx Characteristics -	min.	typ.	max.	unit	
6. Minimum Input Level Sensitivity					
1) 54Mbps (PER ≤ 10%)	-		-65	dBm	





muRata

65Mbps (MCS7) mode unless otherwise specified, 25dea, C, VBAT=3.6V, VDDIO=1.8V

obitibps (MCS7) mode unless otherwise specified. 25deg.C, VBA1-5.0V, VBBIC-1.6V						
Items	Contents					
Specification		IEEE802.11n-2.4G				
Mode		OFDM				
Frequency		2400 - 2483.5MHz				
Data rate	6.5, 13	6.5, 13,19.5, 26, 39, 52, 58.5, 65Mbps				
- DC Characteristics -	min.	typ.	max.	unit		
1. DC current						
1) Tx mode at VBAT	-	175	-	mA		
2) Rx mode at VBAT	-	90	-	mA		
3) Sleep mode at VBAT	-	90	-	uA		
- Tx Characteristics -	min.	typ.	max.	unit		
2. Power Levels		14.0		dBm		
Spectrum Mask			7 / /			
1) at fc +/- 11MHz	-		-20	dBr		
1) at fc +/- 20MHz	-		-28	dBr		
1) at fc +/- 30MHz	-		-45	dBr		
- Rx Characteristics -	min.	typ.	max.	unit		
6. Minimum Input Level Sensitivity						
1) 65Mbps (PER <u>≤</u> 10%)			-64	dBm		





### 12.4 DC/RF Characteristics for Bluetooth 25deg.C, VBAT=3.6V, VDDIO=VDDHOST=1.8V

Items		Cont	onto	
Bluetooth specification Channel spacing	Ver. 4.0 1MHz			
Number of RF channel	1MHZ 79			
Power class	-		9	
Operation mode (Rx/Tx)	Timo divio	ion multiple	v oithar t	ronomit or
Operation mode (RX/TX)		equency hop		
	cycle	equency nor	ping and	OHE KATA
Items	min.	typ.	max.	unit
1. DC Current	111111.	iyp.	max.	unit
1) DH1 Packet 50% Rx/Tx slot duty cycle	_	31		mA
2) DH3 Packet 50% Rx/Tx slot duty cycle	_	40		mA
3) DH5 Packet 50% Rx/Tx slot duty cycle	_	41	-	mA
- TX characteristics -	min.	typ.	max.	unit
2. Output Power	111111.	9.5	max.	dBm
3. Frequency range (Rx/Tx)		2400 - 2483.5		MHz
420dB bandwidth		1400 - 2405.0	1	MHz
5. Adjacent Channel Power *1	-	$\longleftrightarrow$	1	IVII IZ
5.1 [M-N] = 2	-		-20	dBm
5.1 [NI-N] - 2 5.2 [M-N] > 3	-		-40	dBm
6. ICFT (Initial Carrier Frequency Tolerance)	-75		+75	kHz
7. Modulation characteristics	-13		+75	KIIZ
7.1 Modulation offavg	140		175	kHz
7.1 Modulation of ravg  7.2 Modulation of 2max	115		175	kHz
7.2 Modulation of 211 ax  7.3 Modulation of 22 avg/of 12 avg	0.8		-	KΠZ
	0.6		-	_
8. Carrier Frequency Drift 8.1 1slot	-25	_	+25	kHz
8.2 3slot	-40	-	+40	kHz
8.3 5slot	-40	-	+40	kHz
8.4 Maximum drift rate	-20	-	+20	kHz/50µs
9. EDR Relative Power	-20	-	+20	κι 12/30μ5
(Pi/4-DQPSK and 8DPSK)	-4		1	
10. EDR Carrier Frequency Stability and				
Modulation Accuracy				
10.1 ωi (Pi/4-DQPSK and 8DPSK)	-75		75	kHz
10.2 ω0 (Pi/4-DQPSK and 8DPSK)	-10		10	kHz
10.3 ωi+ω0 (Pi/4-DQPSK and 8DPSK)	-75		75	kHz
10.4 RMS DEVM (Pi/4-DQPSK)	-73		20	%
10.5 99% DEVM (Pi/4-DQPSK)	-		30	%
10.6 Peak DEVM (Pi/4-DQPSK)			35	%
10.0 Feak DEVM (FI/4-DQF3K)  10.7 RMS DEVM (8DPSK)	-		13	%
\ /	-			%
10.8 99% DEVM (8DPSK)	-	+	20	%
10.9 Peak DEVM (8DPSK)	-	T	25 may	
- RX characteristics -	min	Тур	max	unit
11. Sensitivity (BER ≤ 0.1%)		<del>                                     </del>	70	dD
11.1 2402MHz	-		-70 -70	dBm
11.2 2441MHz	-		-70 -70	dBm
11.3 2480MHz	-		-70	dBm
12. C/I Performance (BER ≤ 0.1%) *2	-	<del>                                     </del>	44	JD
12.1 co-channel ratio (-60dBm input)	-		11	dB
12.2 1MHz ratio (-60dBm input)	-		0	dB
12.3 2MHz ratio (-60dBm input)	-		-30	dB
12.4 3MHz ratio (-67dBm input)	-		-40	dB



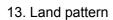
Preliminary Specification Number: SP-ZSTN-C

P. 22/34 12.5 image +/- 1MHz ratio (-67dBm input) -20 dB 13. Blocking performance (BER ≤ 0.1%) \*3 13.1 30MHz-2000MHz -10 dBm 13.2 2000MHz-2400MHz -27 dBm 13.3 2500MHz-3000MHz -27 dBm 13.4 3000MHz-12750MHz -10 dBm -14. Intermodulation performance -39 dBm (BER  $\leq$  0.1%, -64dBm input) 15. Maximum Input Level -20 dBm 16. EDR Sensitivity (at 0.01% BER) 16.1 Pi/4-DQPSK -70 dBm 16.2 8DPSK -70 dBm

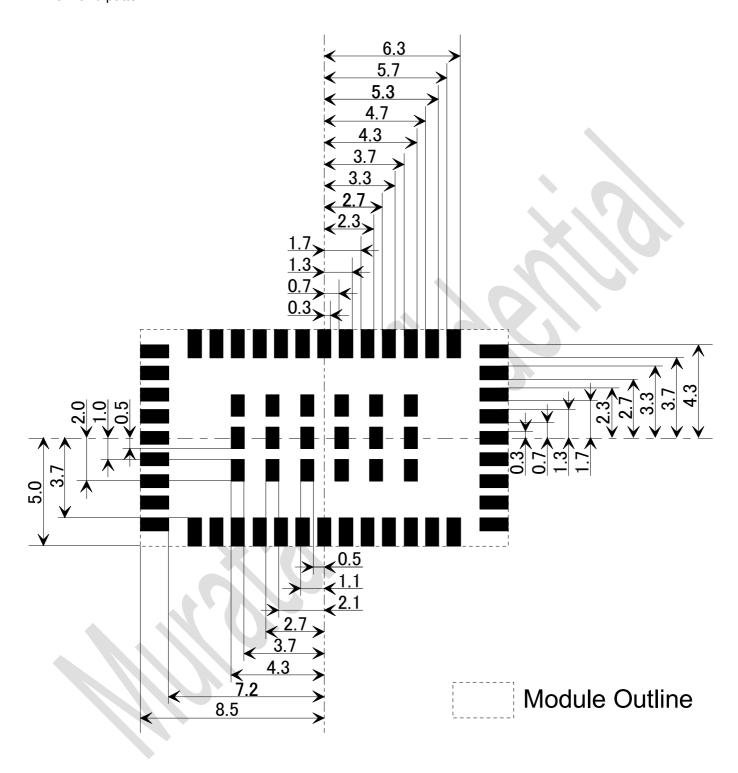
<sup>\*1</sup> Up to three spurious responses within Bluetooth limits are allowed.
\*2 Up to five spurious responses within Bluetooth limits are allowed.

<sup>&</sup>lt;sup>\*3</sup> Up to twenty-four spurious responses within Bluetooth limits are allowed.





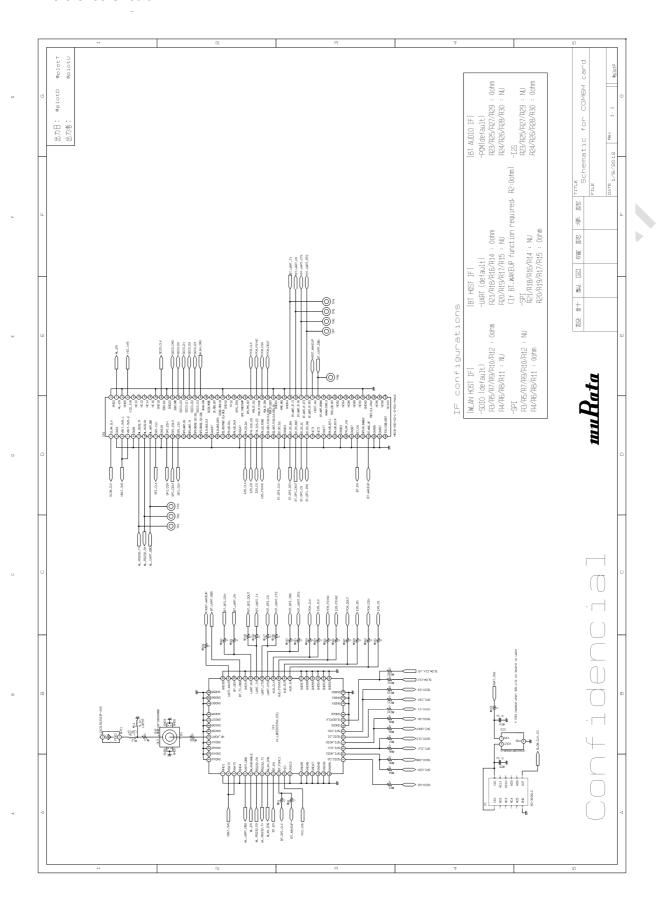
muRata

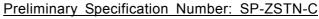


(unit: mm)



#### 14. Reference Circuit







P. 25/34

#### 15. Evaluation board of LBEE5ZSTNC-TEMP

Murata LBEE5ZSTNC-TEMP is compatible to the following evaluation board. Please refer to each operation manual if you would like to get more detail on it.

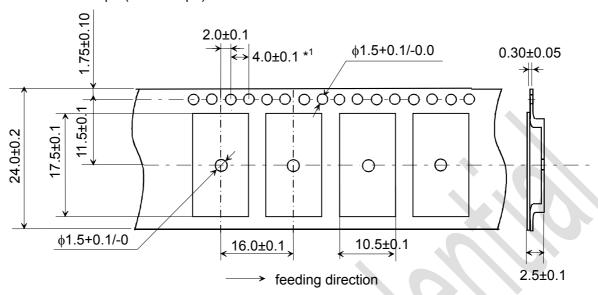
COM6M Evaluation board (Compatible to TI Platform)	Part Number: LBEE5ZSTNC-TEMP-D
--	--------------------------------

P. 26/34



### 16. Tape and Reel Packing

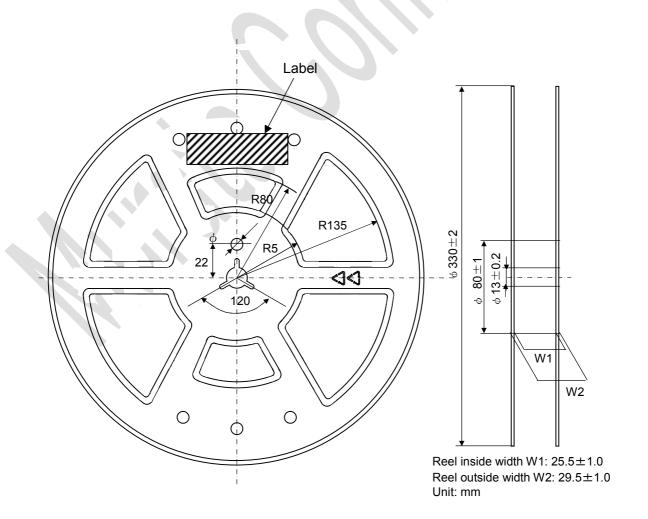
#### (1) Dimensions of Tape (Plastic tape)



\*1 Cumulative tolerance of max. ± 0.3 every 10 pitches

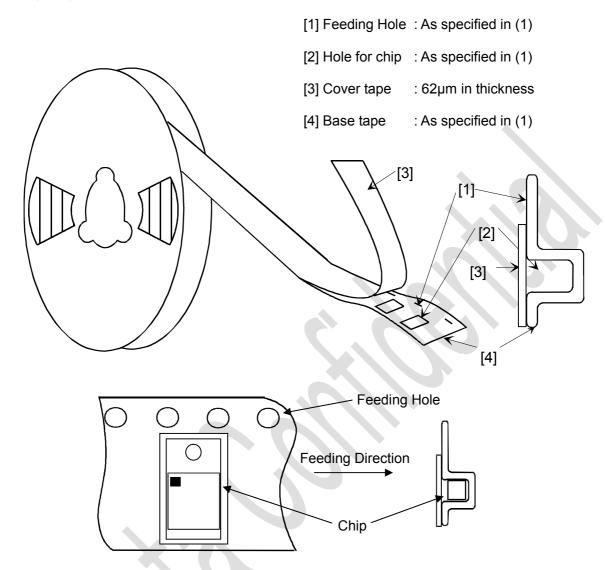
(unit: mm)

#### (2) Dimensions of Reel

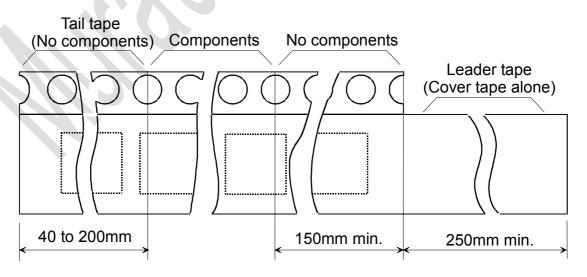




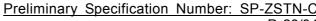
### (3) Taping Diagrams



### (4) Leader and Tail tape



Feeding direction



P 28/34



- (5) The tape for chips are wound clockwise, the feeding holes to the right side as the tape is pulled toward the user.
- (6) The cover tape and base tape are not adhered at no components area for 250mm min.

(7) Tear off strength against pulling of cover tape : 5N min.

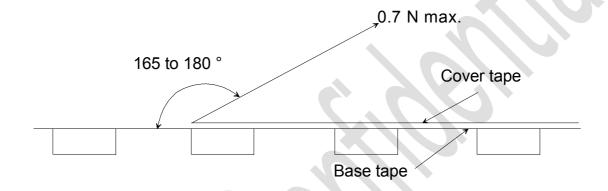
(8) Packaging unit: 500pcs./ reel

(9) material : Base tape : Plastic

Real : Plastic

Cover tape, cavity tape and reel are made the anti-static processing.

(10) Peeling of force: 0.7N max. in the direction of peeling as shown below.





P.29/34



#### NOTICE

### 1. Storage Conditions:

Please use this product within 6 months after receipt.

- The product shall be stored without opening the packing under the ambient temperature from 5 to 35deg.C and humidity from 20 to 70%RH.

(Packing materials, in particular, may be deformed at the temperature over 40deg.C.)

- The product left more than 6months after reception, it needs to be confirmed the solderbility before used.
- The product shall be stored in non corrosive gas (Cl<sub>2</sub>, NH<sub>3</sub>, SO<sub>2</sub>, No<sub>x</sub>, etc.).
- Any excess mechanical shock including, but not limited to, sticking the packing materials by sharp object and dropping the product, shall not be applied in order not to damage the packing materials.

This product is applicable to MSL3 (Based on JEDEC Standard J-STD-020)

- After the packing opened, the product shall be stored at  $\leq$ 30deg.C /  $\leq$ 60%RH and the product shall be used within 168hours.
- When the color of the indicator in the packing changed, the product shall be baked before soldering.

Baking condition: 125+5/-0deg.C, 24hours, 1time

The products shall be baked on the heat-resistant tray because the material (Base Tape, Reel Tape and Cover Tape) are not heat-resistant.

#### 2. Handling Conditions:

Be careful in handling or transporting products because excessive stress or mechanical shock may break products.

Handle with care if products may have cracks or damages on their terminals, the characteristics of products may change. Do not touch products with bear hands that may result in poor solderability.

#### 3. Standard PCB Design (Land Pattern and Dimensions):

All the ground terminals should be connected to the ground patterns. Furthermore, the ground pattern should be provided between IN and OUT terminals. Please refer to the specifications for the standard land dimensions.

The recommended land pattern and dimensions is as Murata's standard. The characteristics of products may vary depending on the pattern drawing method, grounding method, land dimensions, land forming method of the NC terminals and the PCB material and thickness. Therefore, be sure to verify the characteristics in the actual set. When using non-standard lands, contact Murata beforehand.

#### 4. Notice for Chip Placer:

When placing products on the PCB, products may be stressed and broken by uneven forces from a worn-out chucking locating claw or a suction nozzle. To prevent products from damages, be sure to follow the specifications for the maintenance of the chip placer being used. For the positioning of products on the PCB, be aware that mechanical chucking may damage products.



### 5. Soldering Conditions:

Carefully perform preheating so that the temperature difference ( $\Delta T$ ) between the solder and products surface should be in the following range. After mounting, pay special attention to maintain the temperature difference within 100deg.C. Soldering must be carried out by the above mentioned conditions to prevent products from damage. Contact Murata before use if concerning other soldering conditions.

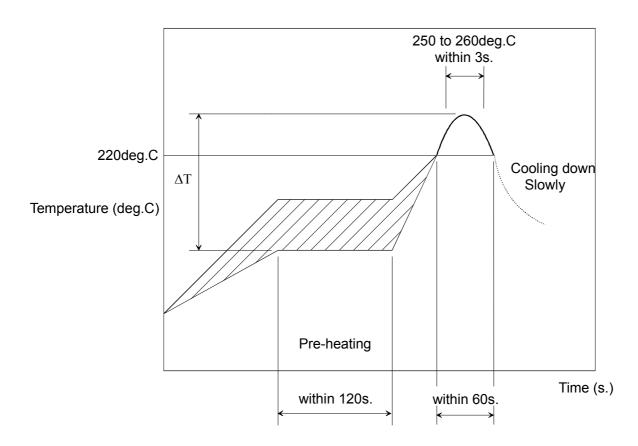
Soldering method	Temperature	
Soldering iron method	^ T<120dog C	
Reflow method	∆T <u>≤</u> 130deg.C	

- Soldering iron method conditions are indicated below.

Kind of iron Item	Ceramics heater		
Soldering iron wattage	<u>≤</u> 18W		
Temperature of iron-tip	<u>≤</u> 350deg.C		
Iron contact time	within 3s.		

- Diameter of iron-tip: Φ3.0mm max.

#### Reflow soldering standard conditions (Example)



Use rosin type flux or weakly active flux with a chlorine content of 0.2wt% or less.



#### 6. Cleaning:

Since this Product is Moisture Sensitive, any cleaning is not permitted.

#### 7. Operational Environment Conditions:

Products are designed to work for electronic products under normal environmental conditions (ambient temperature, humidity and pressure). Therefore, products have no problems to be used under the similar conditions to the above-mentioned. However, if products are used under the following circumstances, it may damage products and leakage of electricity and abnormal temperature may occur.

- In an atmosphere containing corrosive gas (Cl<sub>2</sub>, NH<sub>3</sub>, SO<sub>x</sub>, NO<sub>x</sub> etc.).
- In an atmosphere containing combustible and volatile gases.
- Dusty place.
- Direct sunlight place.
- Water splashing place.
- Humid place where water condenses.
- Freezing place.

If there are possibilities for products to be used under the preceding clause, consult with Murata before actual use.

As it might be a cause of degradation or destruction to apply static electricity to products, do not apply static electricity or excessive voltage while assembling and measuring.

#### 8. Input Power Capacity:

Products shall be used in the input power capacity as specified in this specification. Inform Murata beforehand, in case that the components are used beyond such input power capacity range.



#### 9. Limitation of Applications:

The product is designed and manufactured for consumer application only and is not available for any application listed below which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-processing equipment
- Application of similar complexity and/ or reliability requirements to the applications listed in the above.

#### 10. Underfill Condition:

Halfway underfill on components in the module can make unexpected stress on the components and the module has a possibility not to meet the specification.

In order to avoid this, any underfill shall not be into module inside in case of applying underfill on your PCB.



#### Note:

Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.

All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.

We consider it not appropriate to include other terms and conditions for transaction warranty in product specifications, drawings or other technical documents. Therefore, even if your original part of this product specification includes such terms and conditions as warranty clause, product liability clause, or intellectual property infringement liability clause, we are not able to accept such terms and conditions in this product specification unless they are based on the governmental regulation or what we have agreed otherwise in a separate contact. We would like to suggest that you propose to discuss them under negotiation of contract.



#### Disclaimer

Please read this notice before using the Murata Wireless Modules.

1. Please note that the only warranty that Murata Manufacturing Co., Ltd. ("Murata") provides regarding the products is its conformance to the specifications provided herein. Accordingly, Murata shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this specification.

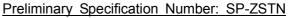
MURATA HEREBY DISCLAIMS ALL OTHER WARRANTIES REGARDING THE PRODUCTS, EXPRESS OR IMPLIED, INCLUDING WITHOUT LIMITATION ANY WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE, THAT THEY ARE DEFECT-FREE, OR AGAINST INFRINGEMENT OF INTELLECTUAL PROPERTY RIGHTS.

YOU AGREE TO INDEMNIFY AND DEFEND MURATA AND ITS AFFILIATES AGAINST ALL CLAIMS, DAMAGES, COSTS, AND EXPENSES THAT MAY BE INCURRED, INCLUDING WITHOUT LIMITATION, ATTORNEY FEES AND COSTS, DUE TO THE USE OF PRODUCTS.

- 2. The product is designed and manufactured for general consumer applications, and not for any particular application, so testing and use of the product shall be conducted at your own risk and responsibility. Specifically, please observe the following:
  - i) Please conduct validation and verification of the products in actual condition of mounting and operating environment before commercial shipment of the equipment.
  - ii) Please pay attention to minimize any mechanical vibration or shock, not to drop the product or a substrate that contains the product during transportation.
  - iii) Since the application of static electricity or overvoltage may cause defect in the product or deterioration of its reliability, caution must be taken against exposure to any static electricity generated by electrified items such as work benches, soldering irons, tools, carrying containers, etc.
  - iv) Caution shall be taken to avoid overstress to the product during and after the soldering process.
  - v) Since the applied soldering method may deteriorate the reliability, thorough evaluation is recommended.
  - vi) In case the product is to be used in equipment or electric circuit that requires high safety or reliability function or performances, sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage. Please provide and appropriate fail-safe function on your product to prevent any damages that may be caused by the abnormal function or the failure of our product.

Notwithstanding the foregoing, the product shall not be used in any application listed below which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-processing equipment
- Application of similar complexity and/ or reliability requirements to the applications listed in the above.







3. Murata's warranty as provided in Clause 1 above that the products comply with descriptions expressly specified in the specifications shall be effective for a period of six (6) months from the date of delivery.

Murata shall not be liable for any defects that occur in dry packed products that are installed more than six (6) months after shipment.

Murata's liability under this warranty shall be limited to products that are returned during the warranty period to the address designated by Murata and that are determined by Murata not to conform to such warranty. If Murata elects to repair or replace such products, Murata shall have reasonable time to repair such products or provide replacements. Repaired products shall be warranted for the remainder of the original warranty period. Replaced products shall be warranted for a new full warranty period.

For avoidance of doubt, Murata shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than Murata including improper installation or testing, or for any products that have been altered or modified in any way by an entity other than Murata. Moreover, Murata shall not be liable for any defects that result from your or third party's design, specifications or instructions for such products.

4. Testing and other quality control techniques are used to the extent Murata deems necessary. Unless mandated by government requirements, Murata does not necessarily test all parameters of each product.

#### 5. EOL

Please note that we may discontinue the manufacture of products, due to reasons such as end of supply of materials and/or components from our suppliers.